

N-channel 60 V, 15 mΩ logic level MOSFET in LFPAK56 16 March 2016

Product data sheet

1. **General description**

Logic level N-channel MOSFET in an LFPAK56 (Power SO8) package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

2. Features and benefits

- Q101 compliant •
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating •
- True logic level gate with V_{GS(th)} rating of greater than 0.5 V at 175 °C

3. Applications

- 12 V Automotive systems
- Motors, lamps and solenoid control
- Transmission control
- Ultra high performance power switching •

Quick reference data 4.

| Table 1. Quie | ck reference data | | | | | | |
|-------------------------|----------------------------------|--|--|-----|------|-----|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | - | 60 | V |
| I _D | drain current | V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u> | | - | - | 53 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | - | 95 | W |
| Static characte | eristics | | | | | | |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 5 V; I _D = 15 A; T _j = 25 °C; <u>Fig. 11</u> | | - | 12.1 | 15 | mΩ |
| Dynamic characteristics | | | | | | | |
| Q _{GD} | gate-drain charge | I _D = 15 A; V _{DS} = 48 V; V _{GS} = 5 V; T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u> | | - | 6 | - | nC |





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5. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|-----------------------------------|--|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | S | source | mb | D |
| 2 | S | source | | |
| 3 | S | source | q | G-UFA |
| 4 | G | gate | មុប្បូប្ | mbb076 S |
| mb | D | mounting base; connected to drain | 1 2 3 4 LFPAK56; Power- SO8 (SOT669) | |

6. Ordering information

| Table 3. Ordering information | | | | | | |
|-------------------------------|-----------------------|--|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| BUK9Y15-60E | LFPAK56; Power-SO8 | Plastic single-ended surface-mounted package (LFPAK56; Power-SO8); 4 leads | SOT669 | | | |

7. Marking

| Table 4. Marking codes | |
|------------------------|--------------|
| Type number | Marking code |
| BUK9Y15-60E | 91560E |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|--|--------|-----|------|------|
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | 60 | V |
| V _{DGR} | drain-gate voltage | R _{GS} = 20 kΩ | | - | 60 | V |
| V _{GS} | gate-source voltage | DC; T _j ≤ 175 °C | | -10 | 10 | V |
| | | Pulsed; T _j ≤ 175 °C | [1][2] | -15 | 15 | V |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | 95 | W |
| I _D | drain current | V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u> | | - | 53 | А |
| | | V _{GS} = 5 V; T _{mb} = 100 °C; <u>Fig. 2</u> | | - | 37.4 | А |
| I _{DM} | peak drain current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$; Fig. 3 | | - | 212 | А |

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| Symbol | Parameter | Conditions | | Min | Мах | Unit |
|----------------------|---|---|--------|-----|------|------|
| T _{stg} | storage temperature | | | -55 | 175 | °C |
| Tj | junction temperature | | | -55 | 175 | °C |
| Source-drain | n diode | | | | | |
| l _S | source current | T _{mb} = 25 °C | | - | 53 | А |
| I _{SM} | peak source current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$ | | - | 212 | А |
| Avalanche r | uggedness | | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | I_D = 53 A; V _{sup} ≤ 60 V; R _{GS} = 50 Ω; V _{GS} = 5 V; T _{j(init)} = 25 °C; unclamped; Fig. 4 | [3][4] | - | 42.7 | mJ |

- Accumulated pulse duration up to 50 hours delivers zero defect ppm Significantly longer life times are achieved by lowering $\rm T_{j}$ and or $\rm V_{GS}$ [1]
- [2]
- Single-pulse avalanche rating limited by maximum junction temperature of 175 °C. [3]
- Refer to application note AN10273 for further information. [4]

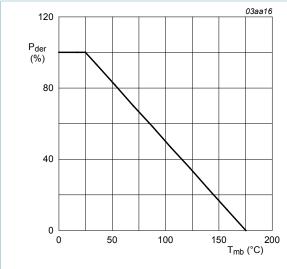


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

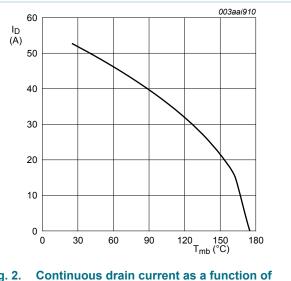
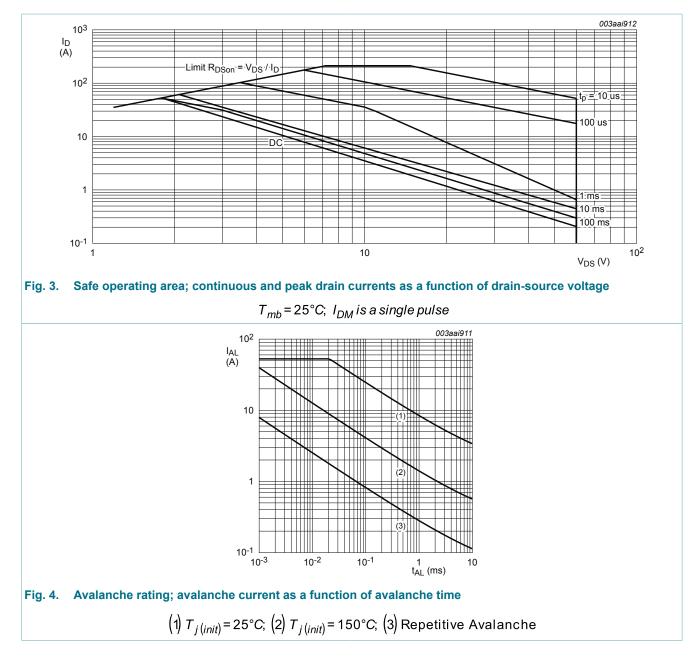


Fig. 2. mounting base temperature

 $V_{GS} \ge 5V$

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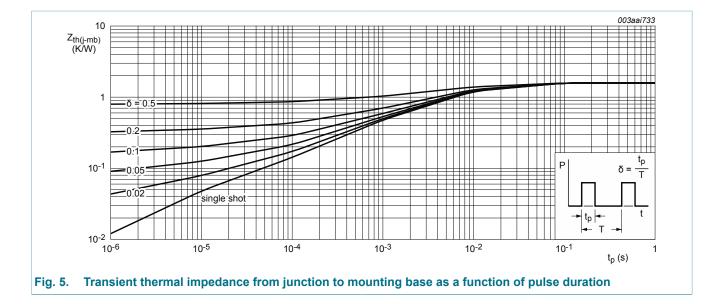


9. Thermal characteristics

| Table 6. The | ermal characteristics | | | | | |
|-----------------------|---|---------------|-----|-----|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| R _{th(j-mb)} | thermal resistance from junction to mounting base | <u>Fig. 5</u> | - | - | 1.58 | K/W |

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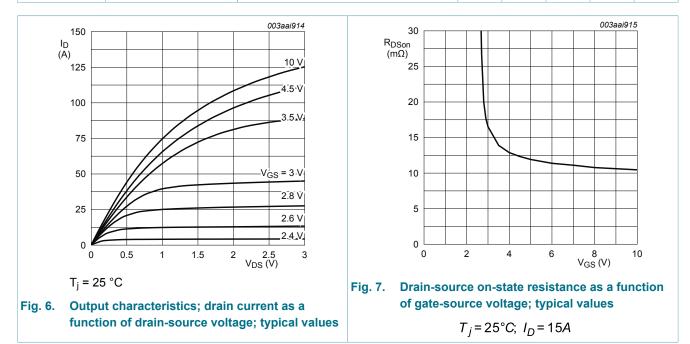
10. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---|--|-----|------|------|------|
| Static chara | acteristics | | | | | |
| V _{(BR)DSS} | drain-source | I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C | 60 | - | - | V |
| | tic characteristics tic characteristics types typ | 54 | - | - | V | |
| V _{GS(th)} | • | ,, | 1.4 | 1.7 | 2.1 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 9</u> | - | - | 2.45 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 9</u> | 0.5 | - | - | V |
| I _{DSS} | drain leakage current | V_{DS} = 60 V; V_{GS} = 0 V; T_j = 25 °C | - | 0.05 | 1 | μA |
| | | V _{DS} = 60 V; V _{GS} = 0 V; T _j = 175 °C | - | - | 500 | μA |
| I _{GSS} | gate leakage current | V_{GS} = 10 V; V_{DS} = 0 V; T_j = 25 °C | - | 2 | 100 | nA |
| | | V_{GS} = -10 V; V_{DS} = 0 V; T_j = 25 °C | - | 2 | 100 | nA |
| R _{DSon} | | V _{GS} = 5 V; I _D = 15 A; T _j = 25 °C; <u>Fig. 11</u> | - | 12.1 | 15 | mΩ |
| | resistance | , | - | 10.8 | 13 | mΩ |
| | | | - | - | 33.9 | mΩ |
| Dynamic ch | naracteristics | · · · · | | | | |
| Q _{G(tot)} | total gate charge | I _D = 15 A; V _{DS} = 48 V; V _{GS} = 5 V; | - | 17.2 | - | nC |
| Q _{GS} | gate-source charge | T _j = 25 °C; <u>Fig. 13; Fig. 14</u> | - | 4.9 | - | nC |
| Q _{GD} | gate-drain charge | | - | 6 | - | nC |

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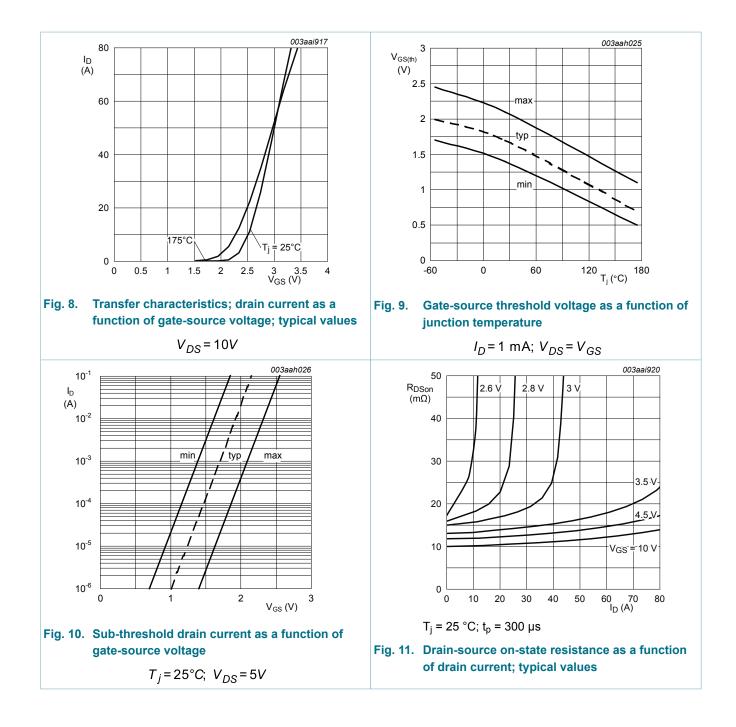
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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|------------------------------|---|-----|------|------|------|
| C _{iss} | input capacitance | V_{DS} = 25 V; V_{GS} = 0 V; f = 1 MHz; | - | 1952 | 2603 | pF |
| C _{oss} | output capacitance | T _j = 25 °C; <u>Fig. 15</u> | - | 182 | 218 | pF |
| C _{rss} | reverse transfer capacitance | $V_{DD} = 45 V' B_1 = 3 O' V_{DD} = 5 V'$ | - | 100 | 137 | pF |
| t _{d(on)} | turn-on delay time | V _{DS} = 45 V; R _L = 3 Ω; V _{GS} = 5 V; R _{G(ext)} = 5 Ω; T _j = 25 °C | - | 11.4 | - | ns |
| t _r | rise time | | - | 17.3 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 25.2 | - | ns |
| t _f | fall time | | - | 15.3 | - | ns |
| Source-dra | ain diode | 1 | | | | |
| V_{SD} | source-drain voltage | I_{S} = 15 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 16</u> | - | 0.83 | 1.2 | V |
| t _{rr} | reverse recovery time | I_{S} = 10 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V; | - | 20.7 | - | ns |
| Q _r | recovered charge | V _{DS} = 25 V; T _j = 25 °C | - | 18.7 | - | nC |



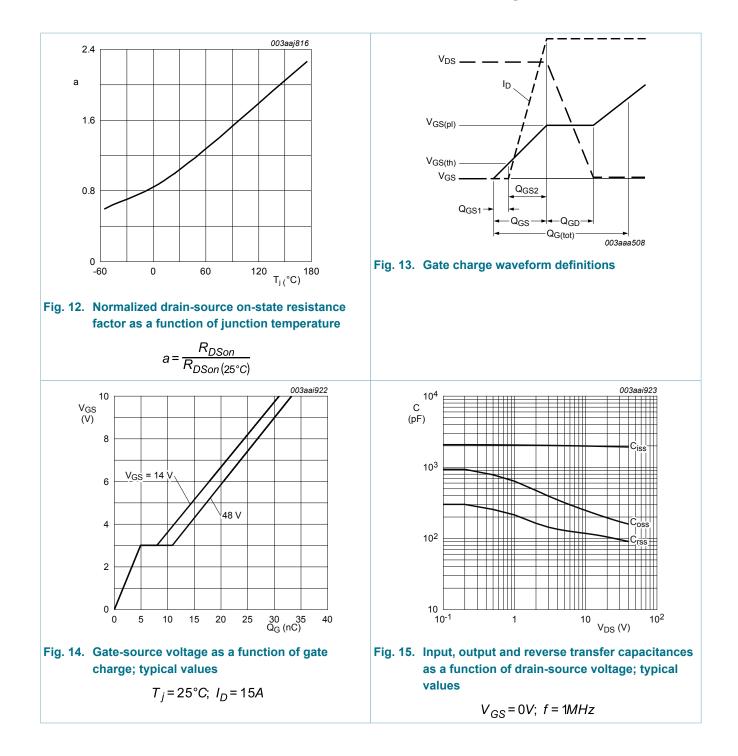
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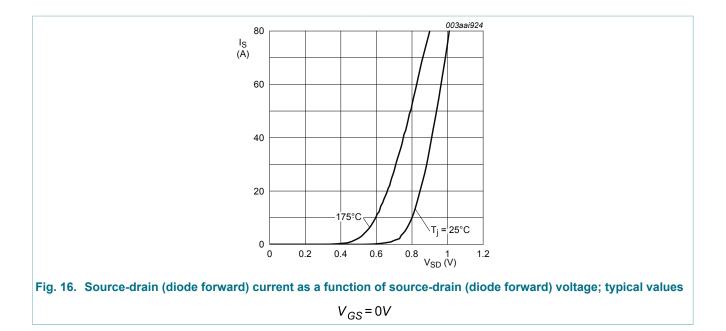
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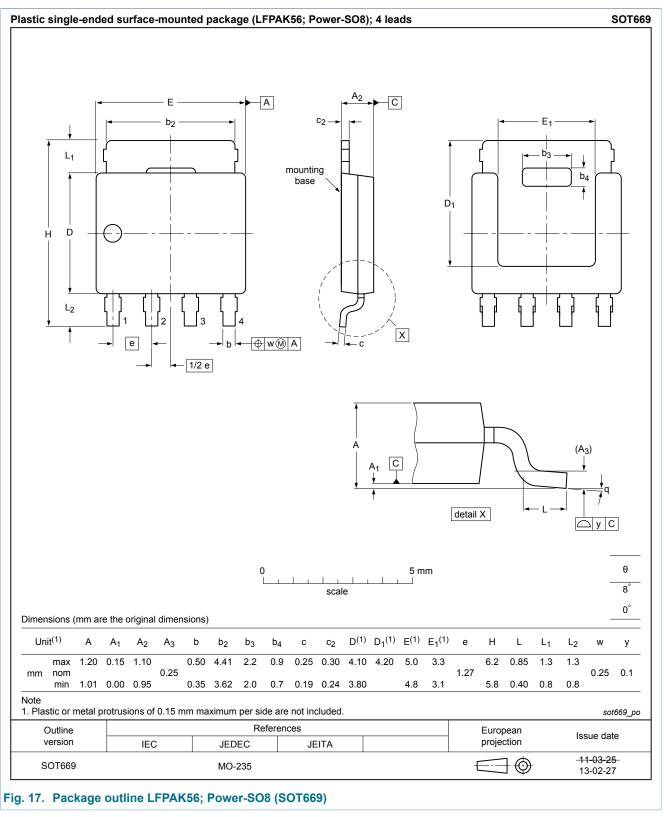
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11. Package outline



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Product data sheet

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12. Legal information

12.1 Data sheet status

| Document status [1][2] | Product status [<u>3]</u> | Definition |
|--------------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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